

ASMP2006

November 29th, 2006

Asian Symposium on
Materials and Processing 2006

Date: November 9-10, 2006

Venue: Sofitel Central Plaza Bangkok, Thailand

Organized by:

Japan Society of Mechanical Engineers, Division of Materials and Processing, Japan
National Metal and Materials Technology Center, NSTDA, Thailand

Best Paper Award

Mechanical Properties Mapping Around Interface of Bonded Materials Using Nanoindentation

Ikuo Ihara, Yuji Kuriyama, futoshi Nishimura, Yukio Miyashita, Naoki Nii, Yoshinori Tanekawa

Study on the Functionality of Nano-Precipitated Calcium Carbonate as Filler in Thermoplastics

Blessie A. Basilia, Marian Elaine G. Panganiban, Achilles Allen V. C. Collado

Rapid Growth of Diamond-Like Carbon Films by Nanopulse Magnetron Chemical Vapor Deposition

Masanori Saito, Takao Saito, Yoshimasa Kondo, Hiroya Murakami, Naoto Ohtake

Effect of Surface Roughness, Powder Size and Pressure on Superplastic Boronizing of Duplex Stainless Steel

H. A. M. Yusof, I. Jauhari, S. Rozali, O. Hiroyuki

A New Method for Evaluating Degradation of Solid Oxide Fuel Cell Under Operating Conditions by Combining the Electrochemical Measurement with Non-Destructive Test

Kazuhisa Sato, Shintaro Kyotani, Toshiyuki Hashida, Hirokazu Moriya, Tatsuya Kawada, Keiji Yashiro, Takashi Nakamura, Hiroo Yugami, Junichiro Mizusaki

Electroplating Technique for Sealing of Thermal Sprayed Coating to Enhance Corrosion Resistance

Hathaipat Koiprasert, Panadda Niranatlumpong

Effect of Temperature on LCF Behavior of 316L(N)/316(N) Weld Joint and 316(N) Weld Metal

G. V. Prasad Reddy, R. Sandhya, M. Valsan, K. Bhanu Sankara Rao

Analysis of Anti-Plane Shear Crack in Finite Thickness Plate

Toshifumi Kakiuchi, Tadashi Shioya, Koji Fujimoto

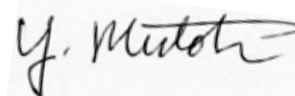
Effect of Temperature on the Warpage Behavior of a Multi-Layered Thin-Core Flexible Substrate

Jonee P. Zuñega, Alberto V. Amorsolo, Jr.

The nine papers listed here have been selected as the BEST PAPER AWARD of this conference through the evaluation of the presentations and the abstracts.

Congratulations.

Chairman of ASMP2006



Yoshiharu Mutoh